

N-Channel Enhancement Mode MOSFET

1. Product Information

1.1 Features

- ☒ Surface-mounted package
- ☒ Advanced trench cell design

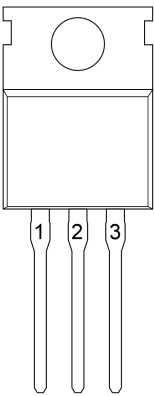
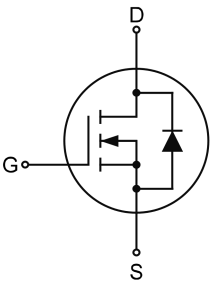
1.2 Applications

- ☒ Motor drivers
- ☒ High power inverter system
- ☒ DC-DC Converter

1.3 Quick reference

- ☒ $BV \geq 150\text{ V}$
- ☒ $R_{DS(ON)} \leq 20\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- ☒ $P_D \leq 125\text{ W}$
- ☒ $R_{DS(ON)} \leq 25\text{ m}\Omega @ V_{GS} = 6\text{ V}$
- ☒ $I_D \leq 55\text{ A}$

2. Pin Description

Pin	Description	Simplified Outline	Symbol
1	Gate (G)	 Top View TO-220	
2	Drain (D)		
3	Source (S)		

3. Limiting Values

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	Drain-Source Voltage	$T_C=25^{\circ}\text{C}$	150	-	V
V_{GS}	Gate-Source Voltage	$T_C=25^{\circ}\text{C}$	-	± 20	V
I_D	Drain Current (DC)	$T_C=25^{\circ}\text{C}, V_{GS}=10\text{ V}$	-	55	A
I_D	Drain Current (DC)	$T_C=100^{\circ}\text{C}, V_{GS}=10\text{ V}$	-	35	A
I_{DM}^*	Drain Current (Pulsed)	$T_C=25^{\circ}\text{C}, V_{GS}=10\text{ V}$	-	165	A
P_D	Drain power dissipation	$T_C=25^{\circ}\text{C}$	-	125	W
I_S	Continuous-Source Current	$T_C=25^{\circ}\text{C}$	-	55	A
E_{AS}	Single Pulsed Avalanche Energy	$V_{DD}=50\text{ V}, L=1.0\text{ mH}$	-	640	mJ
T_J, T_{stg}	Operating Junction and Storage Temperature Range		-55	150	$^{\circ}\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		-	50	$^{\circ}\text{C/W}$
$R_{\theta JC}$	Thermal Resistance, Junction to Case		-	1	

Notes:

- * Pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- ** Surface mounted on 1 in² pad area, $t \leq 10\text{ sec}$.
- *** Limited by bonding wire.

4. Marking Information

Product Name	Marking
KJ40N15C	KJ40N15C XXXXXX-X

5. Ordering Code

Product Name	Package	Reel size	Tape width	Quantity (pcs)
KJ40N15C	TO-220	N/A	N/A	1000

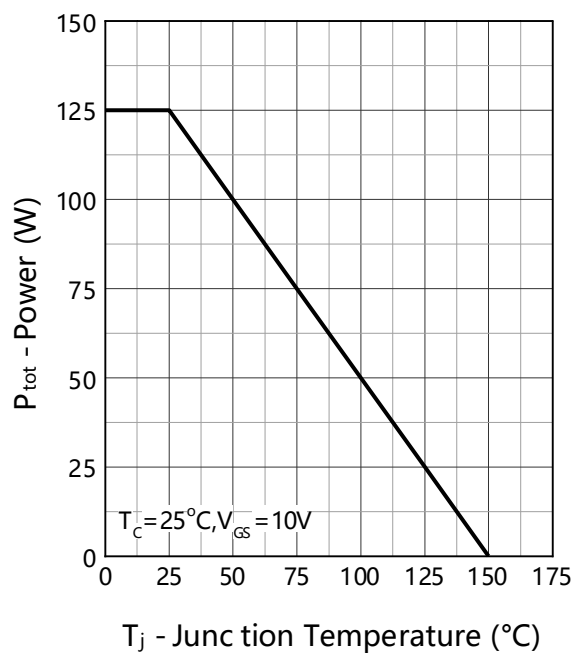
Note: KUIJIEXIN defines "Green" as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C)

6. Electrical Characteristics (T_A=25°C unless otherwise noted)

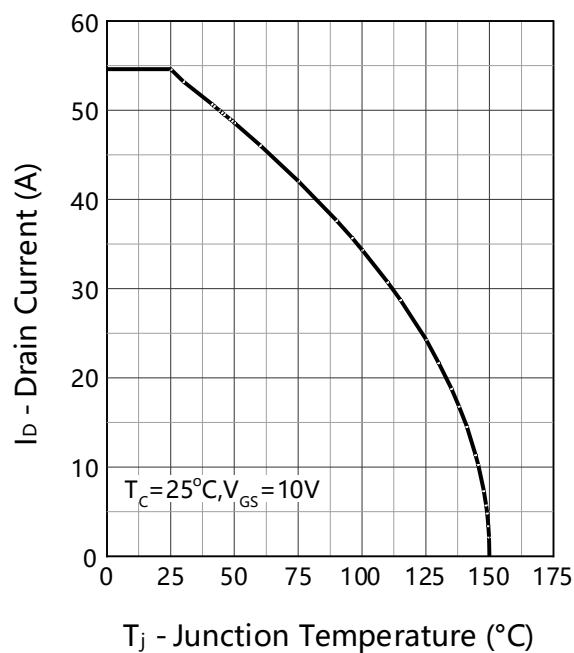
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0 V, I _D =250 μA	150	-	-	V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250 μA	2	-	4	V
I _{DSS}	Zero Gate Voltage Source Current	V _{DS} =120 V, V _{GS} =0 V	-	-	1	μA
I _{GSS}	Gate Leakage Current	V _{GS} =±20 V, V _{DS} =0 V	-	-	±100	nA
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10 V, I _D =15 A	-	15.5	20	mΩ
		V _{GS} =6 V, I _D =10 A	-	20.5	26	
Diode Characteristics						
V _{SD}	Diode Forward Voltage	I _{SD} =15 A, V _{GS} =0 V	-	0.85	1.3	V
t _{rr}	Reverse Recovery Time	I _{SD} =15 A, dI _{SD} /dt=100 A/μs	-	72	-	ns
Q _{rr}	Reverse Recovery Charge		-	236	-	nC
Dynamic Characteristics						
C _{iSS}	Input Capacitance	V _{GS} =0 V, V _{DS} =40 V Frequency=1 MHz	-	2400	-	pF
C _{oSS}	Output Capacitance		-	750	-	
C _{rSS}	Reverse Transfer Capacitance		-	30	-	
t _{d(on)}	Turn-on Delay Time	DS=75 V, V _{GEN} =10 V, R _G =3 Ω, R _L =5 Ω, I _{DS} =15 A	-	16	-	ns
t _r	Turn-on Rise Time		-	19	-	
t _{d(off)}	Turn-off Delay Time		-	25	-	
t _f	Turn-off Fall Time		-	9	-	
Gate Charge Characteristics						
Q _g	Total Gate Charge	V _{DS} =75 V, V _{GS} =10 V, I _{DS} =15 A	-	35	-	nC
Q _{gs}	Gate-Source Charge		-	10	-	
Q _{gd}	Gate-Drain Charge		-	8	-	

7. Typical Characteristics

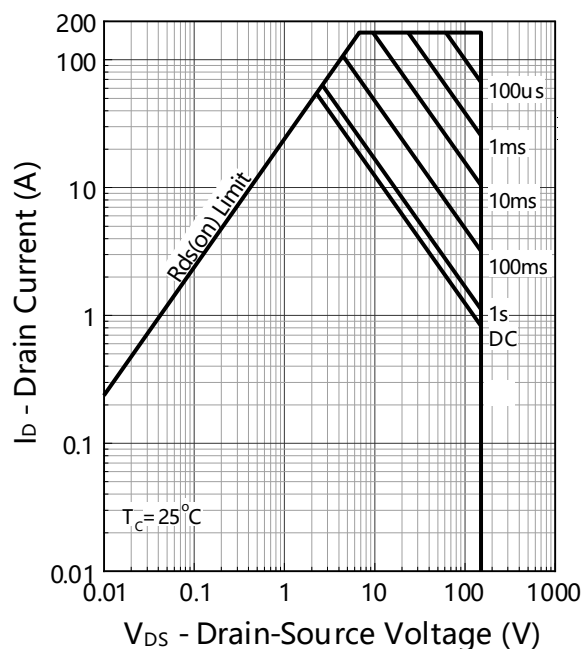
Power Capability



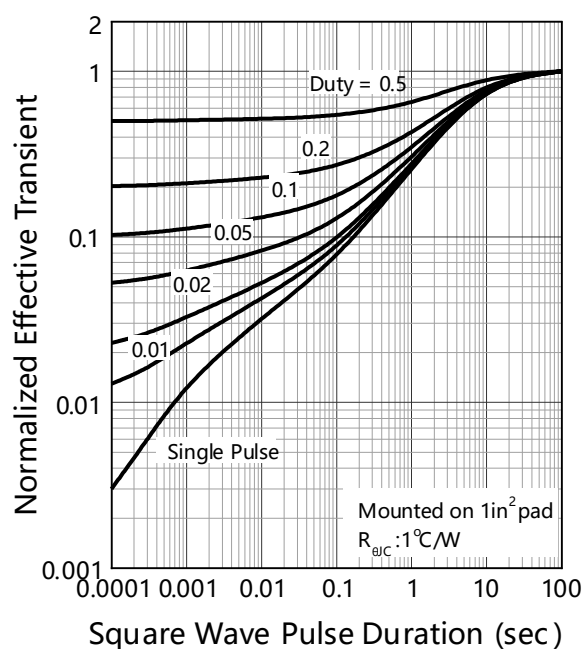
Current Capability



Safe Operation Area

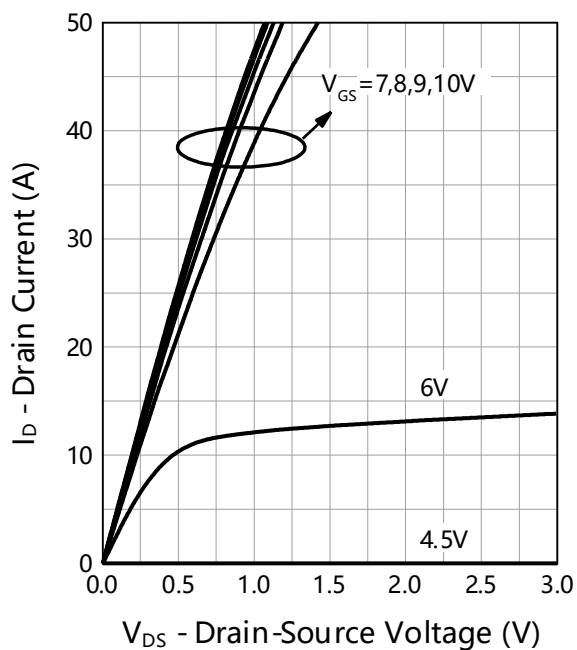


Transient Thermal Impedance

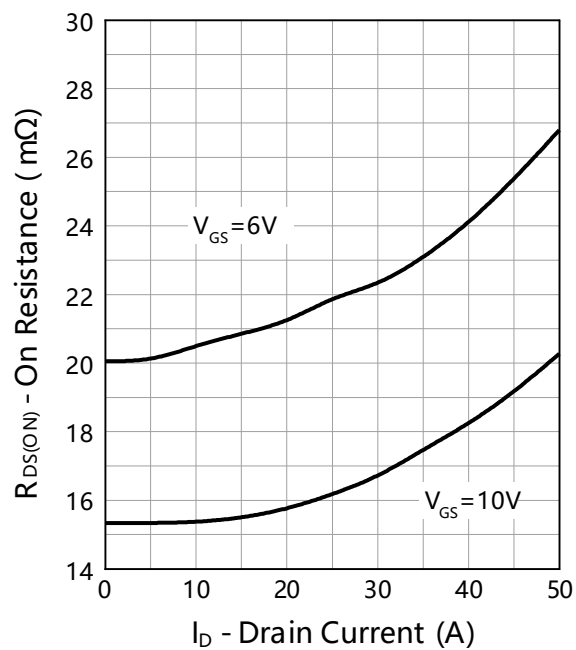


7. Typical Characteristics (cont.)

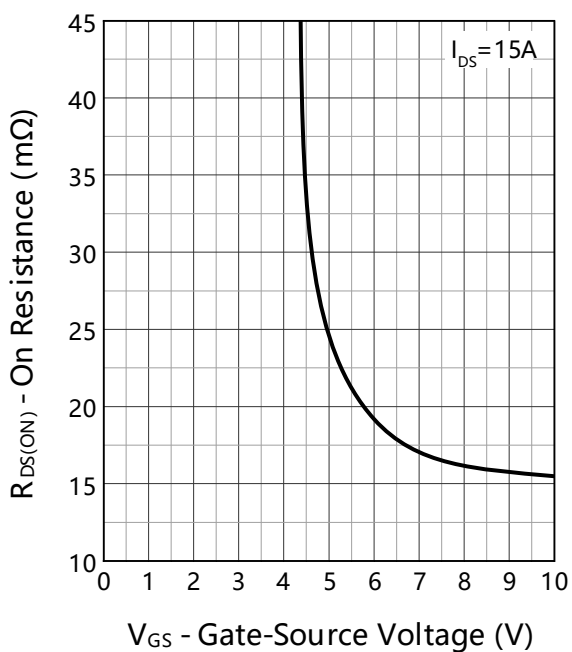
Output Characteristics



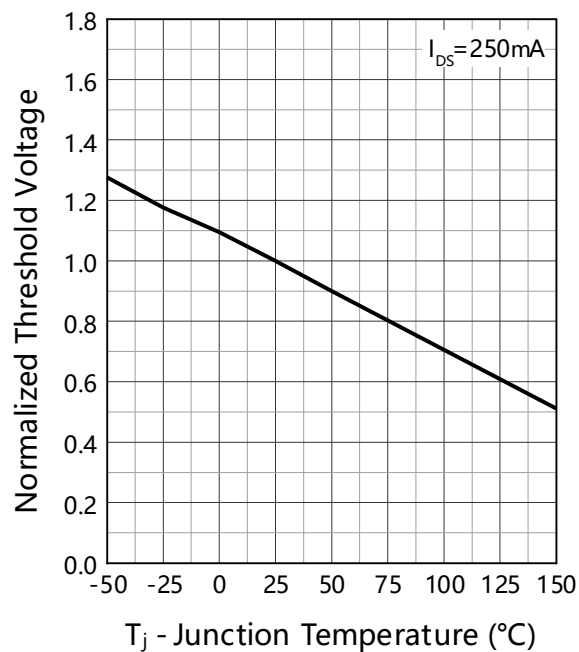
On Resistance



Transfer Characteristics

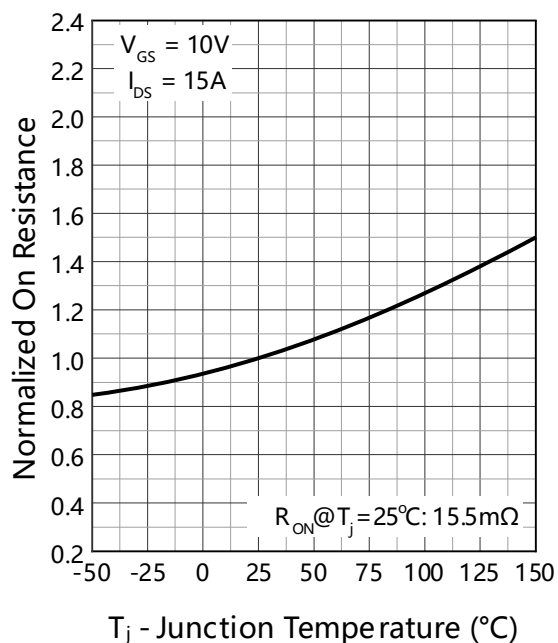


Normalized Threshold Voltage

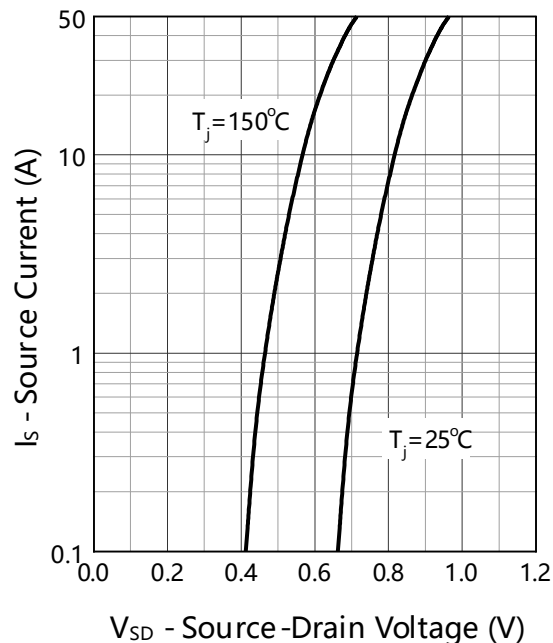


7. Typical Characteristics (cont.)

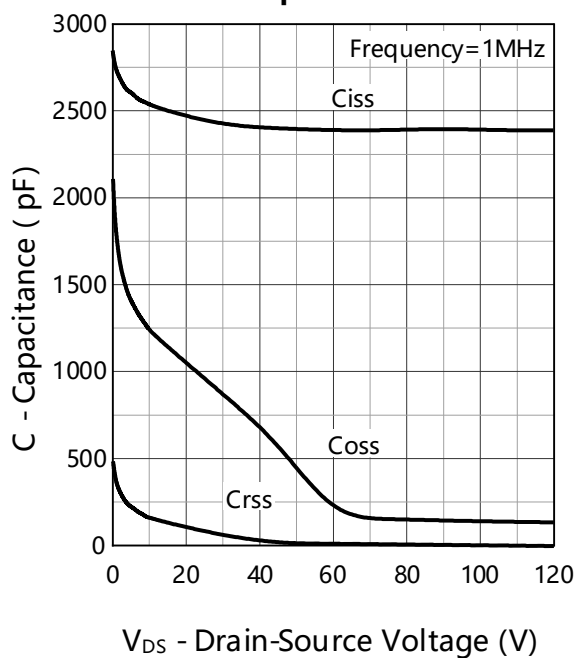
Normalized On Resistance



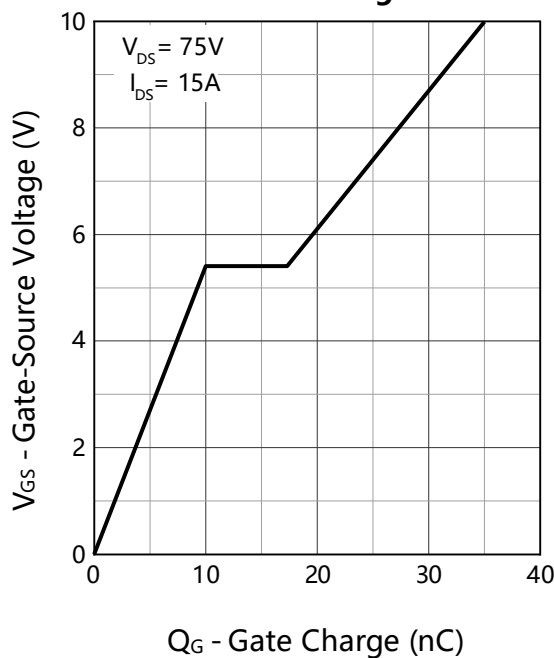
Diode Forward Current



Capacitance

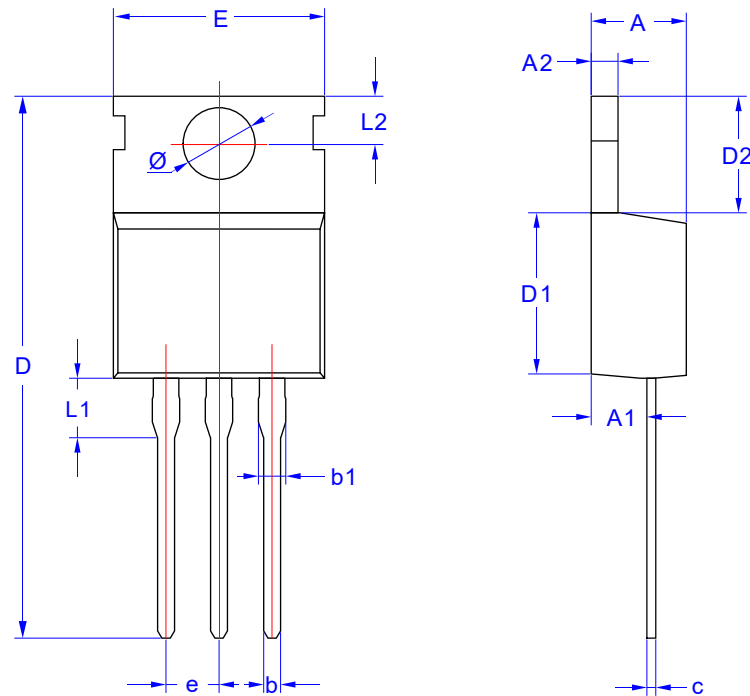


Gate Charge



8. Package Dimensions

TO-220 Package



Symbol	Dimensions in Millimeters	
	MIN	MAX
A	4.24	4.70
A1	2.20	3.00
A2	1.15	1.40
b	0.70	0.95
b1	1.14	1.70
c	0.40	0.60
D	28.0	29.8
D1	8.80	9.90
D2	6.25	6.90
E	9.70	10.50
L1	3.80	
L2	2.40	3.00
e	2.54 BSC	
ϕ	3.60	